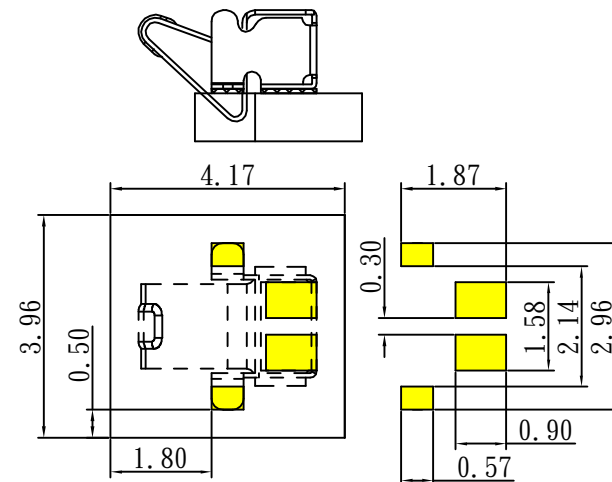
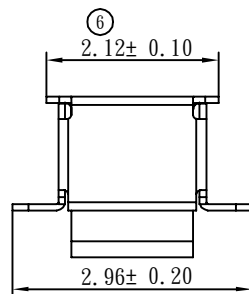
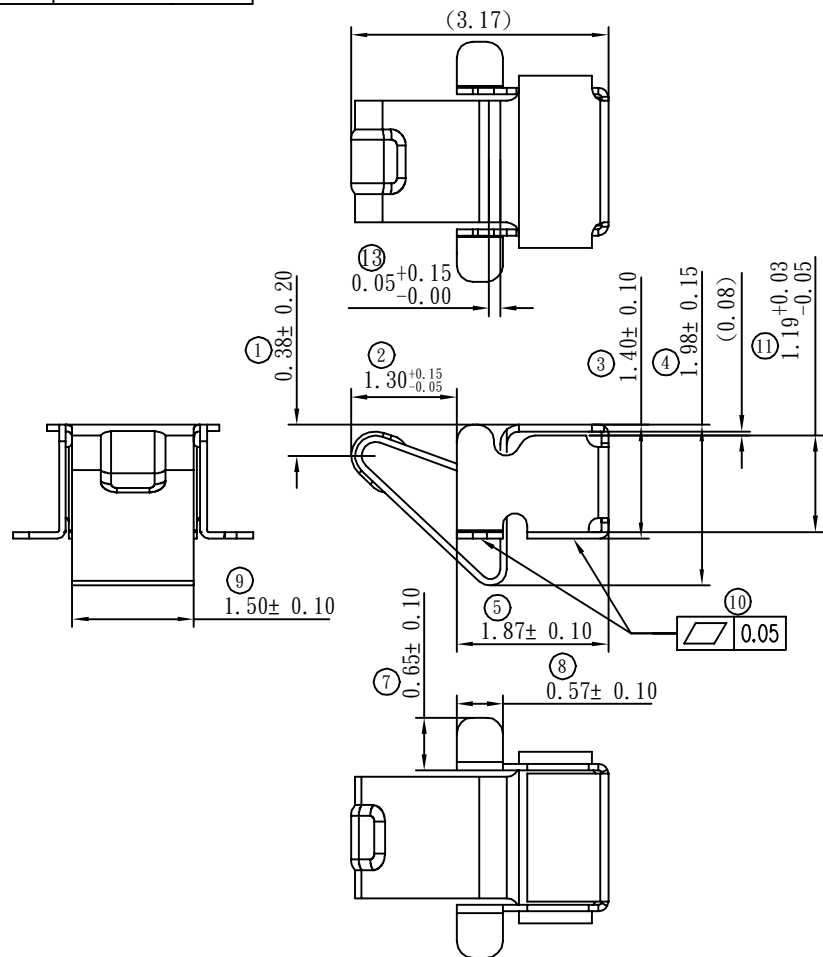


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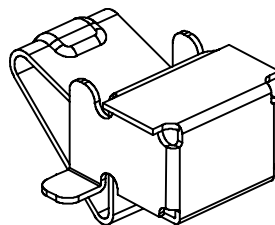


RECOMMENDED SOLDERING PCB LAYOUT

TOLERANCE(.XX±0.05)

Note:

1. Material: Titanium Copper Thickness 0.08mm
2. Electroplate:
Au >1u" on contact area
Au >1u" on solder area
Nickel underplating over all
3. Electrical Characteristics:
3-1 Current Voltage: 12V
3-2 Current Rate: 3A
3-3 Contact Resistance: Normal Compression <30mΩ
4. Working Range of Application: 0.30~0.60 mm
5. Spring Force Tolerance is ± 20gf
6. Operating Temperature: -20℃~+85℃



TOLERANCE/CLASS			
RANGE(mm)	1	2	3
≤ 30	± 0.10	0.15	0.20
30 < - ≤ 120	± 0.15	0.20	0.30
120 < - ≤ 300	± 0.20	0.30	0.50
300 < -	± 0.30	0.50	0.80
ANGLES	± 2.5°		

00	12/25-'15	Design creation	
REV	Date	Description	
DRAFT Danny Liao		DATE 12/25-'15	RoHS Compatible
CHECKER Justin Wu		DATE 12/25-'15	
APPROVAL Jacky Lin		DATE 12/25-'15	SHEET 1-2
		SCALE Not to scale	UNIT mm



EMI STOP CORP.

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JC-323020G

CUS P/N